



**Government
eProcurement
System**

Government eProcurement System

Tender Details

Date : 30-Oct-2023 04:32 PM

Print

Basic Details

Organisation Chain	Indian Institute of Technology Madras Project Purchase - IITM		
Tender Reference Number	MS/BOBY/043/2023/SMARTTEMP		
Tender ID	2023_IITM_172515_1	Withdrawal Allowed	Yes
Tender Type	Open Tender	Form of contract	Supply
Tender Category	Goods	No. of Covers	2
General Technical Evaluation Allowed	No	ItemWise Technical Evaluation Allowed	No
Payment Mode	Not Applicable	Is Multi Currency Allowed For BOQ	No
Is Multi Currency Allowed For Fee	No	Allow Two Stage Bidding	No

Cover Details, No. Of Covers - 2

Cover No	Cover	Document Type	Description
1	Fee/PreQual/Technical	.pdf	Technical Bid
2	Finance	.xls	Financial Bid

Tender Fee Details, [Total Fee in ₹ * - 0.00]

Tender Fee in ₹	0.00		
Fee Payable To	Nil	Fee Payable At	Nil
Tender Fee Exemption Allowed	No		

EMD Fee Details

EMD Amount in ₹	0.00	EMD through BG/ST or EMD Exemption Allowed	No
EMD Fee Type	fixed	EMD Percentage	NA
EMD Payable To	Nil	EMD Payable At	Nil

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Work / Item(s)

Title	Smart Temperature profiler for Reflow oven				
Work Description	Smart Temperature profiler for Reflow oven				
Pre Qualification Details	Please refer Tender documents.				
Independent External Monitor/Remarks	NA				
Show Tender Value in Public Domain	No				
Tender Value in ₹	0.00	Product Category	Miscellaneous Goods	Sub category	NA
Contract Type	Tender	Bid Validity(Days)	120	Period Of Work (Days)	21
Location	Central Electronics Centre, IIT-Madras	Pincode	600036	Pre Bid Meeting Place	NA
Pre Bid Meeting Address	NA	Pre Bid Meeting Date	NA	Bid Opening Place	Central Electronics Centre, IIT-Madras
Should Allow NDA Tender	No	Allow Preferential Bidder	No		

Critical Dates

Publish Date	30-Oct-2023 05:50 PM	Bid Opening Date	21-Nov-2023 03:00 PM
Document Download / Sale Start Date	30-Oct-2023 05:55 PM	Document Download / Sale End Date	20-Nov-2023 03:00 PM
Clarification Start Date	NA	Clarification End Date	NA
Bid Submission Start Date	31-Oct-2023 09:00 AM	Bid Submission End Date	20-Nov-2023 03:00 PM

Tender Documents

NIT Document	S.No	Document Name	Description	Document Size (in KB)
	1	Tendernotice_1.pdf	As per tender document	1131.46

Work Item Documents	S.No	Document Type	Document Name	Description	Document Size (in KB)
	1	Tender Documents	tenderdoc.pdf	Tender Document	1117.36
	2	BOQ	BOQ_188992.xls	BOQ	298.50

Auto Extension Corrigendum Properties for Tender

Iteration	No. of bids required for bid opening a tender	Tender gets extended to No. of days
1.	2	7

Bid Openers List

S.No	Bid Opener Login Id	Bid Opener Name	Certificate Name
1.	cmfa-icsr@imail.iitm.ac.in	Ravi Sadagopan	SADAGOPAN RAVI
2.	smpur-icsr@iitm.ac.in	Chandramohan Gunaseelan	Chandramohan G
3.	icsrpur.advisor@iitm.ac.in	YOGANANDA M	M Yogananda
4.	tender@imail.iitm.ac.in	Thanga Pandian P	THANGA PANDIAN P

GeMARPTS Details

GeMARPTS ID	PQF3CVRBEV3W
Description	Smart Temperature profiler for Reflow oven
Report Initiated On	26-Oct-2023
Valid Until	25-Nov-2023

Tender Properties

Auto Tendering Process allowed	No	Show Technical bid status	Yes
Show Finance bid status	Yes	Show Bids Details	No
BoQ Comparative Chart model	Normal	BoQ Compative chart decimal places	2
BoQ Comparative Chart Rank Type	L	Form Based BoQ	No
Show Bid Details in Public Domain stage	Technical Bid Opening		

TIA Undertaking

S.No	Undertaking to Order	Tender complying with Order	Reason for non compliance of Order
1	TIA UNDERTAKING GEM	Agree	
2	PPP-MII Order 2017	Agree	
3	MSEs Order 2012	Agree	

Tender Inviting Authority

Name	The Senior Manager, Project Purchase
Address	The Senior Manager, Project Purchase, ICSR,IIT Madras, Chennai-600036

Tender Creator Details

Created By	YOGANANDA M
Designation	SENIOR MANAGER
Created Date	30-Oct-2023 12:09 PM